



34.9	33.5	30	39-29-8131	5268-13A-X	13
29.9	28.5	25	-8111	-11A-X	11
24.9	23.5	20	-8091	-09A-X	9
19.9	18.5	15	-8071	-07A-X	7
17.4	16	12.5	-8061	-06A-X	6
14.9	13.5	10	-8051	-05A-X	5
12.4	11	7.5	-8041	-04A-X	4
9.9	8.5	5	-8031	-03A-X	3
C	B	A	EDP NO.	ENG. NO.	NO. OF CKTS.

NOTES

- I. MATES WITH : 5264 SERIES
- △ APPLIES : PIN, BOTH ENDS

REVISED EC NO: J2016-0761 DRWR: TANAKA02 2016/01/20 CHKD: SAKIYAMA 2016/02/03 APPR: KANEKO 2016/02/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	0.25 UNDER	UNDER	±0.03	DRAWN BY T. ITO	DATE 1991/12/06	TITLE 2.5 LOW PROFILE WAFER ASSY 90 DEGREES BEND	
	0.25 OVER	0.5 UNDER	±0.05	CHECKED BY M. FUKUSHIMA	DATE 1992/08/31	MATERIAL NO. SEE CHART	
	0.5 OVER	1.0 UNDER	±0.1	APPROVED BY	DATE	DOCUMENT NO. SD-5268-NA-X	SHEET NO. 1 OF 1
	1.0 OVER	10 UNDER	±0.2	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
10 OVER	30 UNDER	±0.25	SIZE A3				
30 OVER		±0.3					